

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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PNZ327 (PN327)

Silicon planar type

For optical control systems

■ Features

- Fast response which is well suited to high speed modulated light detection: t_r , $t_f = 50$ ns (typ.)
- High sensitivity, high reliability
- Peak emission wavelength matched with infrared light emitting diodes: $\lambda_p = 900 \text{ nm}$ (typ.)
- Wide detection area, wide half-power angle: $\theta = 70^{\circ}$ (typ.)

■ Absolute Maximum Ratings $T_a = 25$ °C

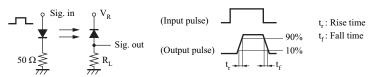
Parameter	Symbol	Rating	Unit
Reverse voltage	V_{R}	30	V
Power dissipation	P _D	100	mW
Operating ambient temperature	T _{opr}	-30 to +85	°C
Storage temperature	T _{stg}	-40 to +100	°C

■ Electrical-Optical Characteristics $T_a = 25$ °C±3°C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Sensitivity to infrared radiation *1	S _{IR}	$V_R = 5 \text{ V, H} = 0.1 \text{ mW/cm}^2$	4.5		Jilo)	μΑ
Photocurrent *2	$I_{\rm L}$	$V_R = 10 \text{ V}, L = 1000 \text{ lx}$	30	70		μΑ
Drain current	I_{D}	$V_R = 10 \text{ V}$		5	50	nA
Terminal capacitance	C _t	$V_R = 0 \text{ V, } f = 1 \text{ MHz}$		70	3,	pF
Peak sensitivity wavelength	$\lambda_{ ext{PD}}$	$V_R = 10 \text{ V}$	11/10	900		nm
Half-power angle	θ	The angle when sensitivity to infrared radiation is halved		70		0
Rise time *3	t _r	V 10VP 110	50.	50		ns
Fall time *3	t_{f}	$V_R = 10 \text{ V}, R_L = 1 \text{ k}\Omega$		50		ns
Rise time *3	t _r	V 10 V D 10010		5		μs
Fall time *3	$t_{\rm f}$	$V_R = 10 \text{ V}, R_L = 100 \text{ k}\Omega$		5		μs

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

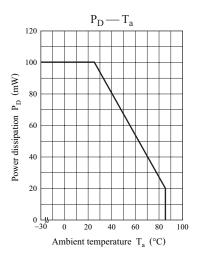
- 2. Spectral sensitivity characteristics: Sensitivity for wave length over 400 nm maximum sensitivity ratio is 100%.
- 3. This device is designed by disregarding radiation.
- 4. *1:Source: Infrared emitters ($\lambda = 940 \text{ nm}$)
 - *2:Source: Tungsten lamp (color temperature 2 856K)
 - *3: Switching time measurement circuit

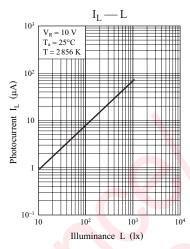


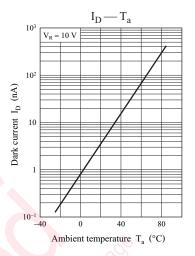
Note) The part number in the parenthesis shows conventional part number.

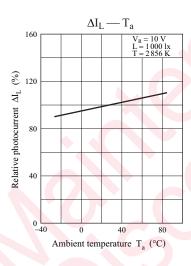
PNZ327

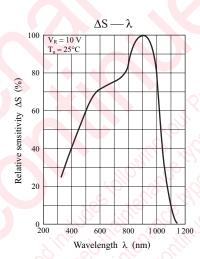
Panasonic

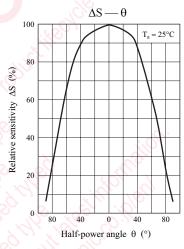


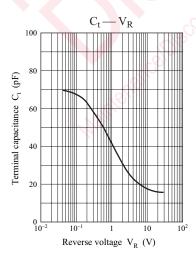


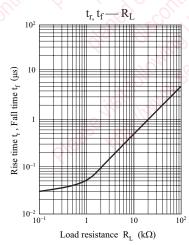


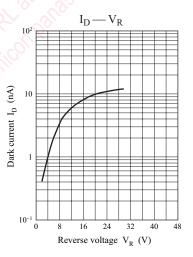










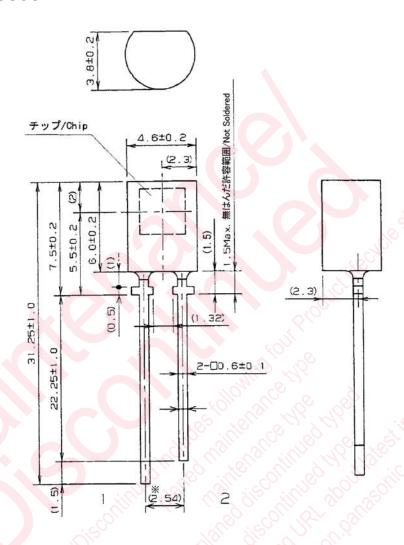


2 SHE00038DED

Panasonic PNZ327

■ Package (Unit: mm)

LPXFSN2S0001



- Pin name
 - 1: Anode
 - 2: Cathode

SHE00038DED 3

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